

UFSD Charge Collection Studies with the UCSC β -Telescope

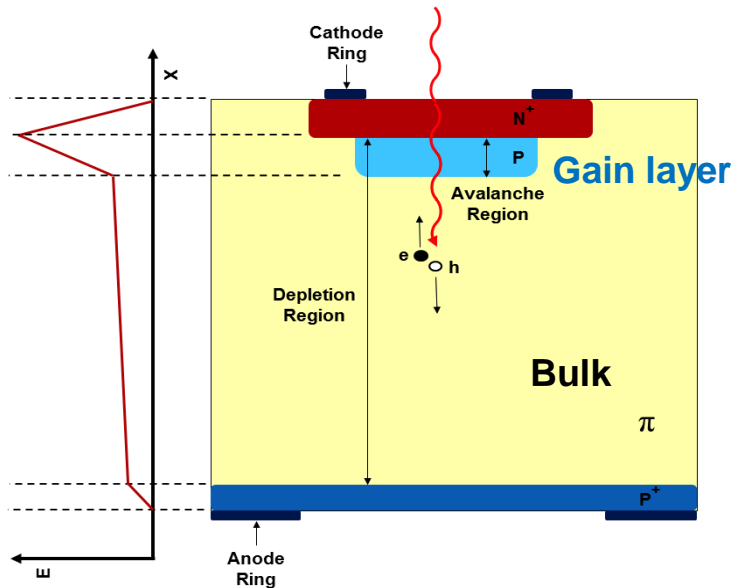
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Measurements of the gain and the time resolution
of neutron irradiated Ultra-fast Silicon Detectors (UFSD)

- FBK: LGAD with carbon-implanted boron gain layer (B+C)
- HPK: LGAD with thin bulk (35 μm)

Issues for Low-Gain Avalanche Diodes LGAD

By now we have been working on Ultra-fast Silicon Detectors for about 6 years. LGAD sensors were proposed and manufactured first by CNM Barcelona and with the addition of FBK and HPK we have now (at least) three commercial manufacturers.



Even then, radiation damage is still an issues which limits the designs and applications of the LGADs. This is due to the fact that we have to consider the effects in both sections of the LGAD:

1. acceptor removal In the p-multiplication gain layer
2. acceptor generation, trapping, leakage current, drift time etc in the p-type bulk.

We have measured the charge collection in LGAD designs which address mitigation steps of radiation damage in the two sensors sections:

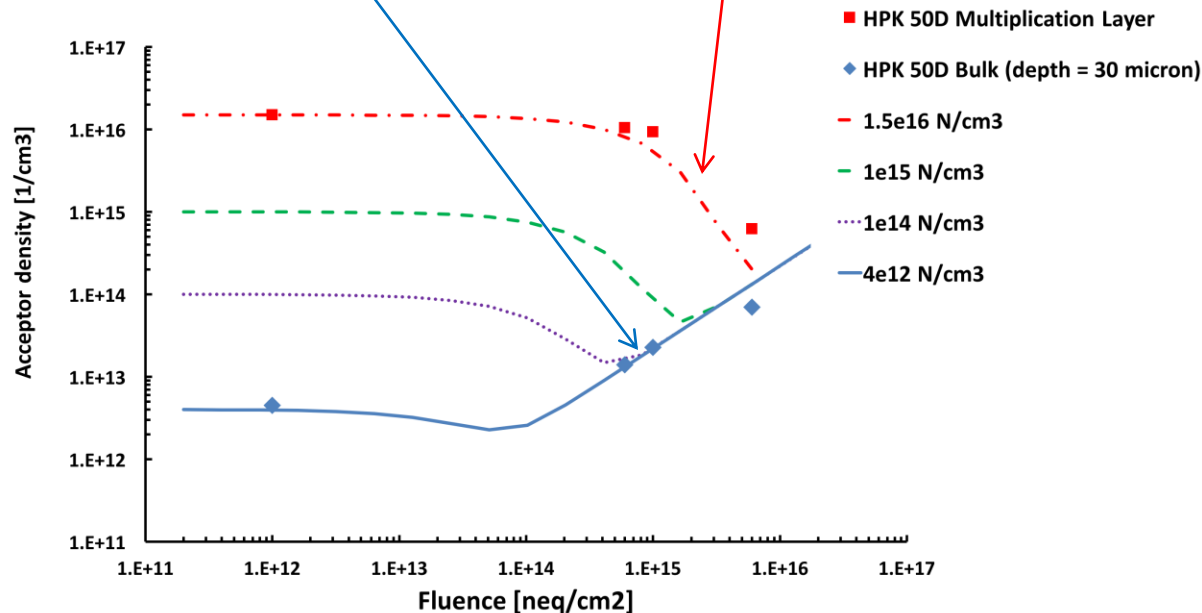
1. Addition of carbon in the gain layer (FBK)
2. Reduction of the drift distance , i.e. the thickness of the bulk (HPK)

Acceptor Removal & Creation

All silicon sensors experience creation of acceptors proportional to fluence,
An LGAD specific effect is the gain decrease due to acceptor removal in the gain layer.

Acceptor density vs. fluence:

Increases in low density bulk, decrease in high density gain layer.



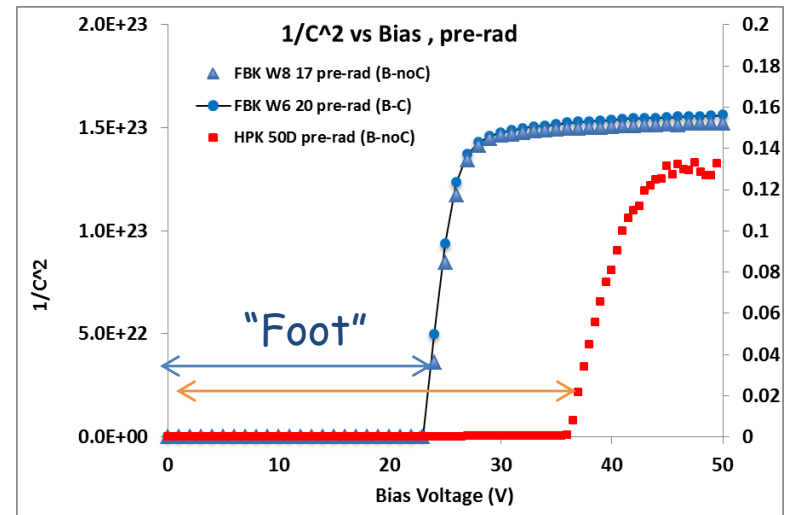
Z. Galloway et al, arXiv:1707.04961

Data from C-V scans on HPK 50D

Simulation from Weightfield 2 (WF2) incorporating G. Kramberger's work.

Carbon implanted LGAD: Doping

- FBK 50 μm
 - W6: B-doping with Carbon (B+C)
 - W8: B-doping without Carbon (B-noC)
 - :
 (compare to):
- HPK 50 μm LGAD without Carbon
 - 50D (B-noC)



Identical C-V curves for FBK W6(B+C) and W8(B-noC)

Different doping profile of multiplication layer and bulk for FBK and HPK

Rise time difference between FBK and HPK indicates small difference in thickness

Depletion Voltage of gain layer ("Foot"):

FBK: 23 V

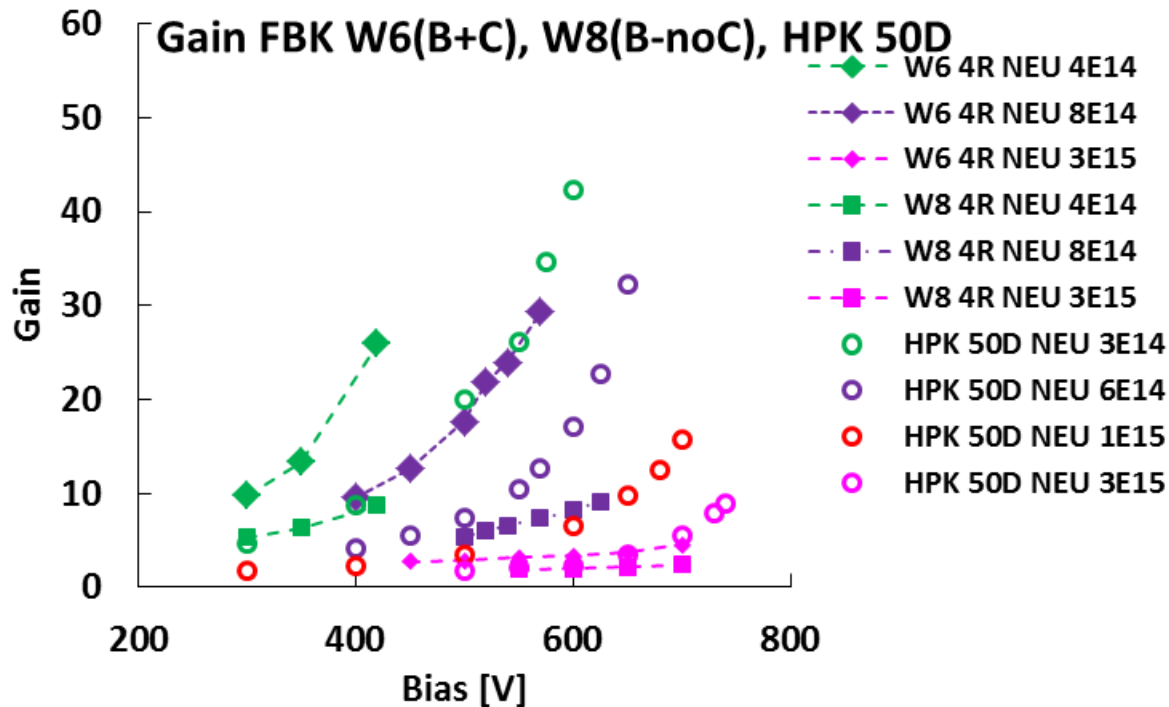
HPK: 36 V

Slope (reflects the doping of the bulk):

Lower in HPK: -> higher doping in bulk, higher bias needed

Details of the carbon-implanted LGAD are presented in papers 92,93,95

Bias Dependence of Gain



FBK devices have filled symbols and are connected by lines

Fluence color code

3e14, , 4e14

6e14, 8e4

1e15

3e15

Effect of Initial conditions:

Consequence of higher doping in HPK: **higher bias**

Consequence of carbon implantation in FBK W6(B+C): **higher gain** than W8(B-noC)

Time Resolution (optimized CFD%)

Fluence color code

3e14, , 4e14, 6e14, 8e14, 1e15, 3e15

All LGAD achieve time resolution below 50 ps at all fluences

Compare FBK C vs. noC

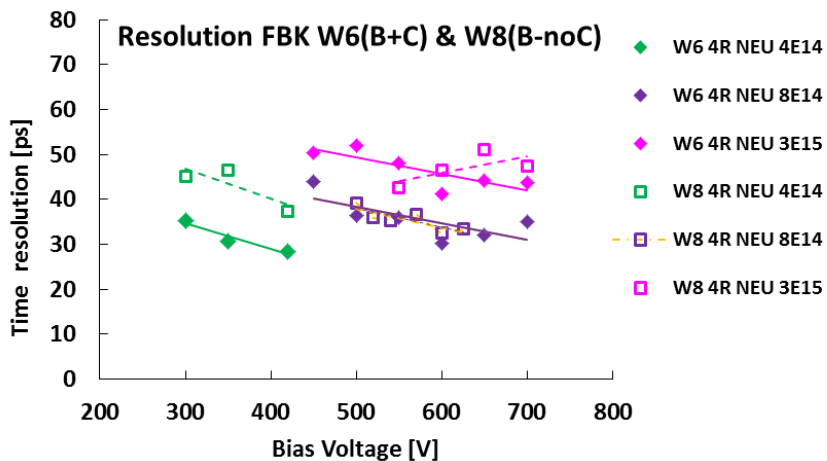
W6(B+C) superior to W8(B-noC) at fluences below $\sim 8e14$ n/cm², but equivalent to it above.

Compare FBK W6(B+C) to HPK 50D (B-noC)

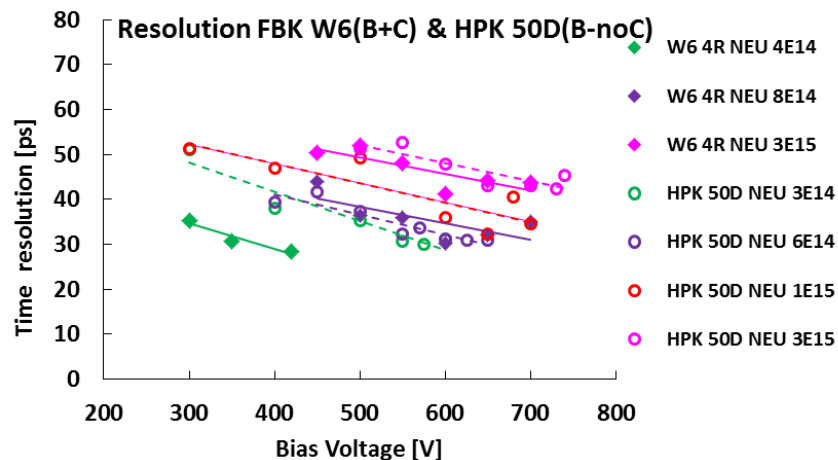
W6(B+C) superior at same bias or fluences below $8e14$.

But HPK(B-noC) reaches same resolution as W6(B+C) at higher bias

Once the acceptors are mostly removed and a major part of the gain originates in the bulk, (i.e. fluences $> 1e15$ n/cm²) the time resolution appears to be the same for B+C and B-noC.



(N.B. Straight lines to guide the eye only)



Data acquisition and analysis :
Z. Galloway et al, arXiv:1707.04961

Largest beneficial effect of C-implantation is observed at fluences below $1\text{e}15\text{ n/cm}^2$ where a large part of the gain is due to the multiplication layer doping.

An observed benefit of the C-implantation is the reduced bias voltage required for the same gain and resolution, which might mitigate the problem of supplying bias to a detector with large fluence variation like the HGTD in ATLAS.

At higher fluences, the benefit of C-implantation could not be established.

One possible explanation is that at that point the gain from the bulk is dominating.

Comparison HPK 50 μm and 35 μm LGAD

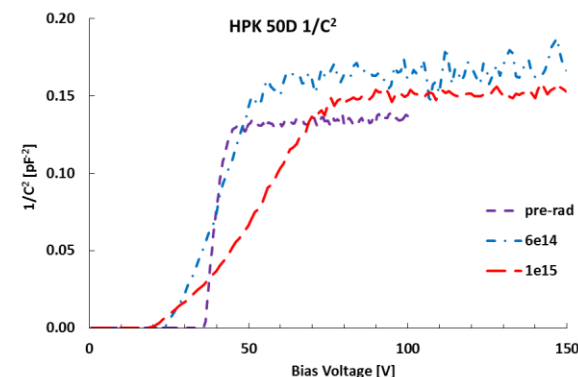
50 μm thick LGAD (HPK 50D)

Z. Galloway et al., arXiv: 1707.04961

Multiplication layer ("foot"): 36 V

Depletion $V_{\text{dep}} = 45$ V

Pre-rad bulk: 2×10^{12}

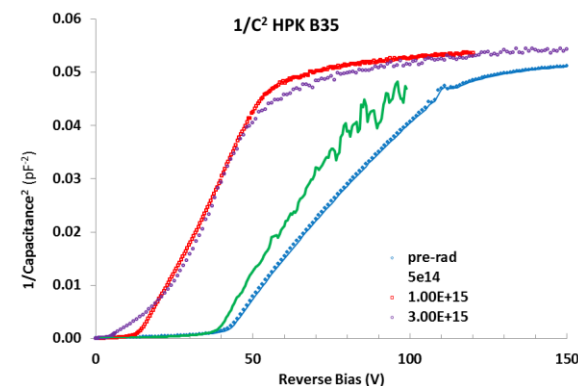


35 μm thick LGAD (HPK B35)

Multiplication layer ("foot"): 41 V

Depletion $V_{\text{dep}} = 130$ V

Pre-rad bulk: 1×10^{14} , "sweet spot" bulk doping: almost constant during irradiation



Question:

is B35 fluence really 5×10^{14} or actually 1×10^{14} ??

Will later assume the latter.

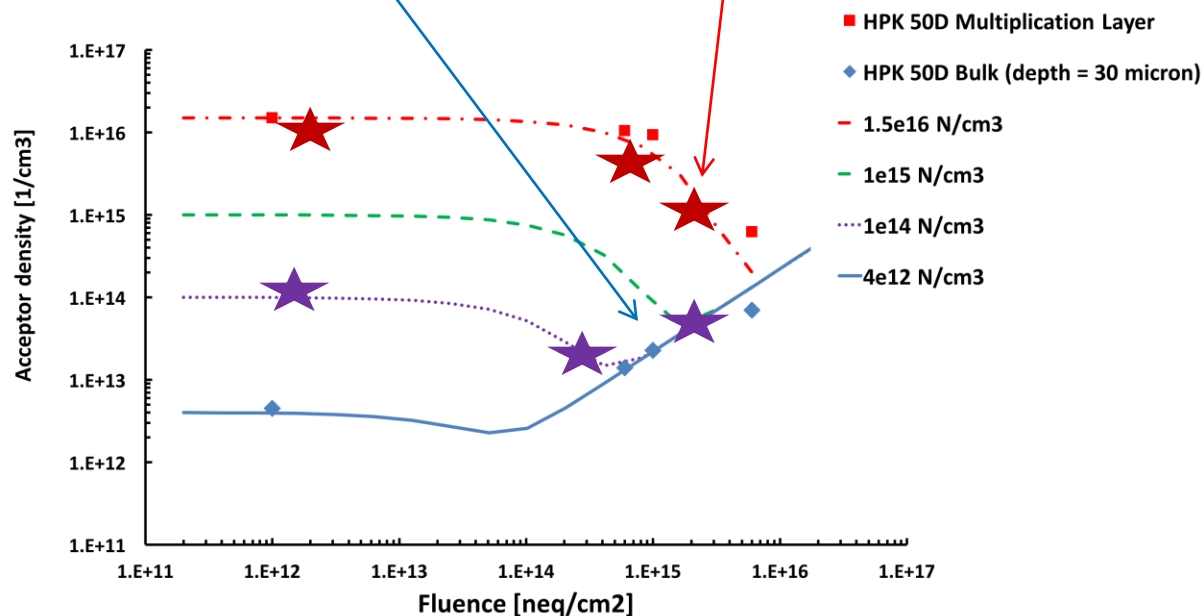
Measured in the UCSC β -telescope at -20° & -30° C

pre-rad and after neutron fluences (5×10^{14}) 1×10^{14} , $\sim 1 \times 10^{15}$ n/cm², & proton fluence 3×10^{15} n/cm²

All silicon sensors experience creation of acceptors proportional to fluence,
An LGAD specific effect is the gain decrease due to acceptor removal in the gain layer.

Acceptor density vs. fluence:

Increases in low density bulk, decrease in high density gain layer.



B35 Bulk



B35 Multiplication Layer

Data from C-V scans with B35

Simulation from WF2 incorporating G. Kramberger's work

Bias Dependence of Gain

Gain determines the signal strength and thus jitter.

Bias determines the signal shape and thus the rise time and jitter.

$$\sigma_{TimeWalk} = \left[\frac{V_{th}}{S/t_{rise}} \right]_{RMS} \propto \left[\frac{N}{dV/dt} \right]_{RMS}$$

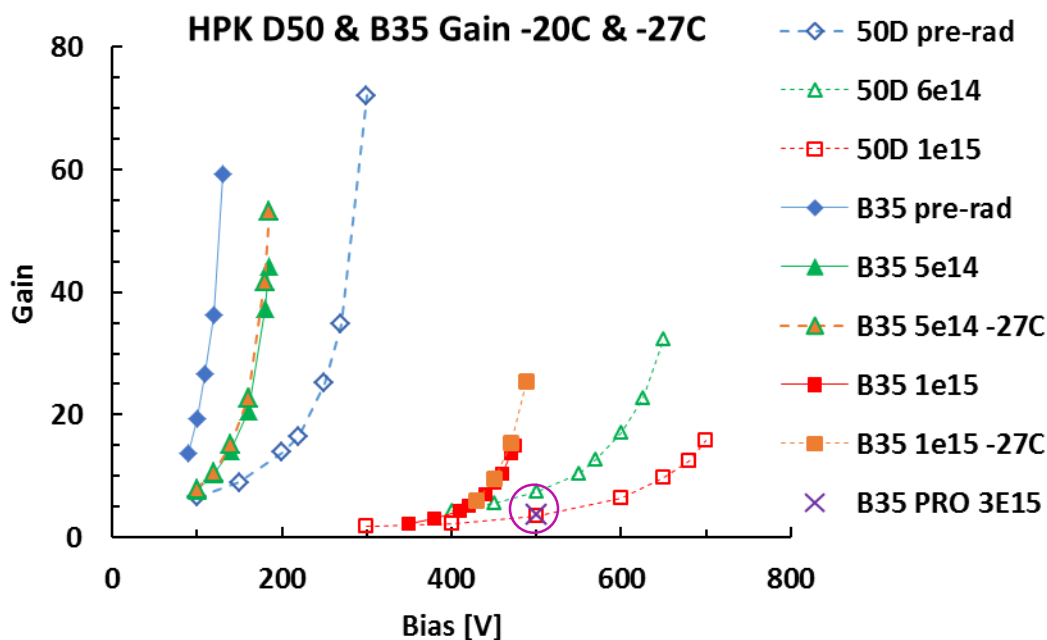
$$\sigma_{Jitter} = \frac{N}{dV/dt} \approx \frac{t_{rise}}{S/N}$$

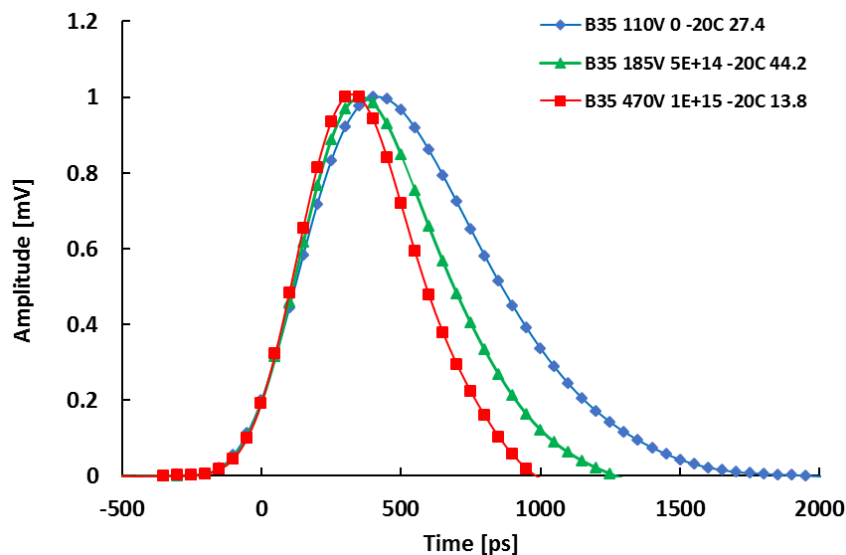
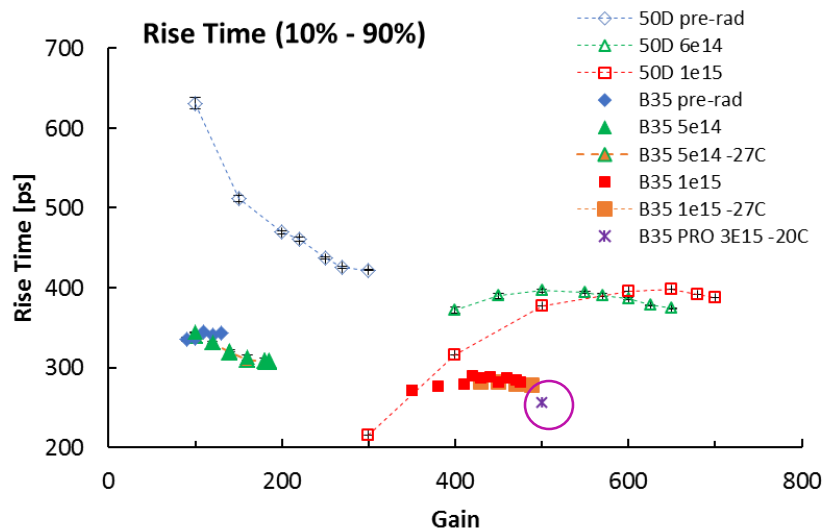
Sharp rise of gain with bias.

Doping of B35 gain layer is too high such that it can only be operated at low bias (close to depletion)

Lower temperature permits higher bias.

B35 irradiated up to $5e15$ protons/cm² has gain of about 4





Rise Time

Before radiation:

- 343 ps (35 μ m) vs. 422 ps (50 μ m)

After 1e15 n/cm²

- 284 ps (35 μ m) vs. 387 ps (50 μ m)

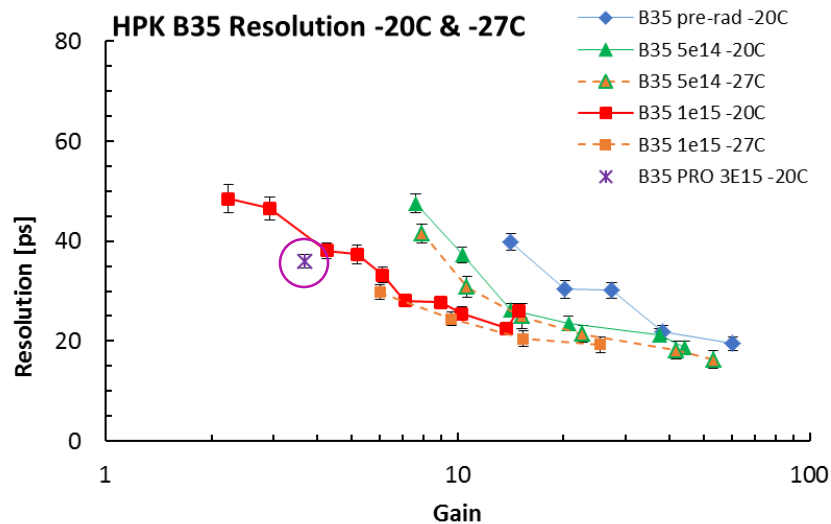
B35 irradiated up to 5e15 protons/cm² has a rise time below 250 ps:

Can an ASIC be built which can explore this?.

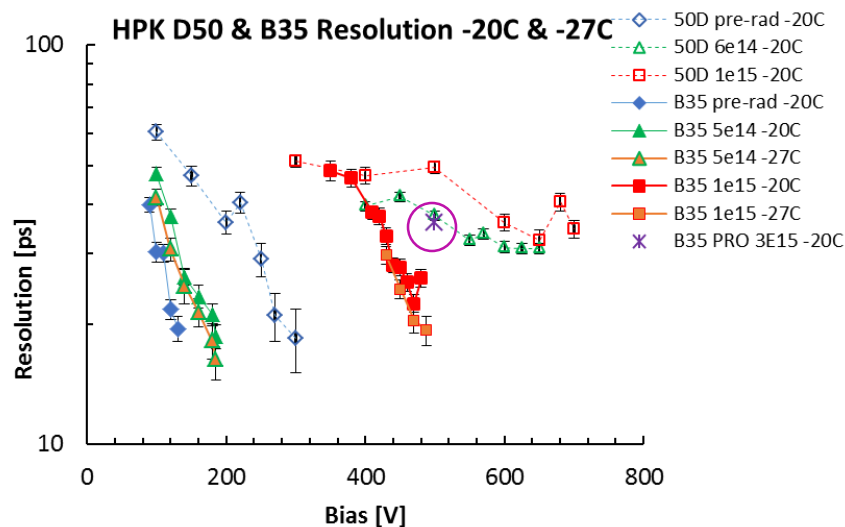
Pulse shapes

Normalized pulse shapes show that the low bias voltage of B35 pre-rad causes slower charge collection and larger rise time

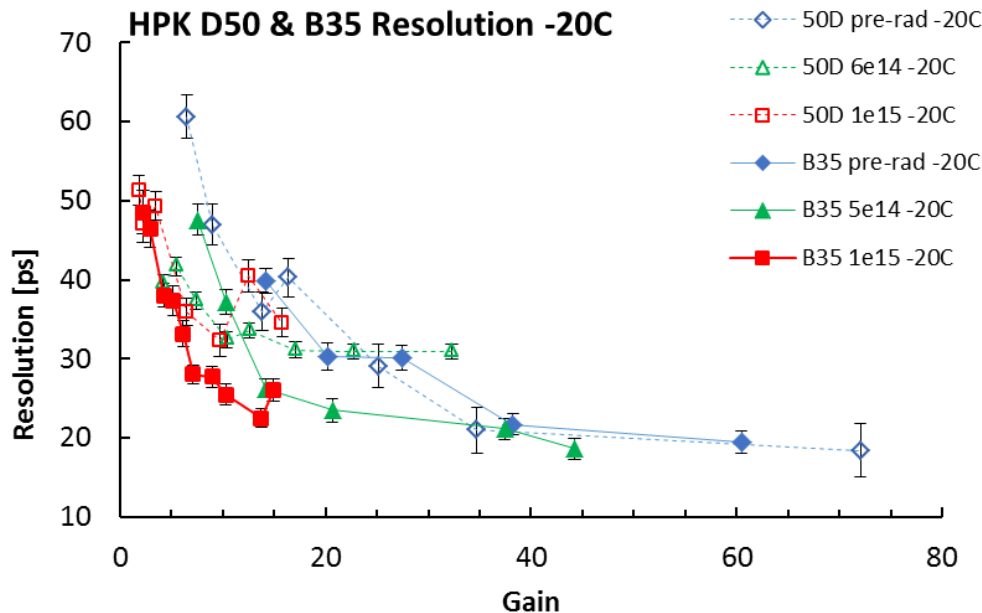
Time resolution vs. Gain & Bias



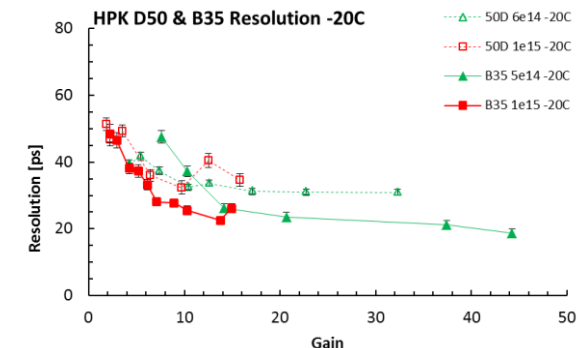
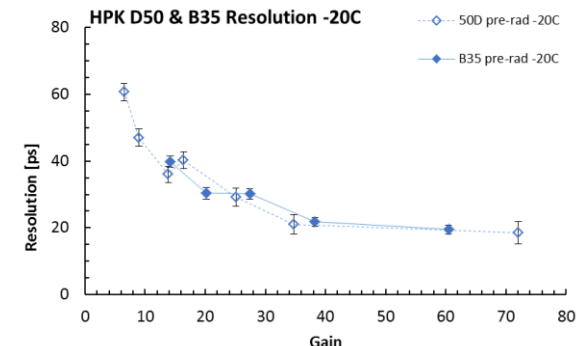
Lowered temperature permits larger gain and improves time resolution



Steep voltage dependence of B35: gain layer doping too high (?)



$$\sigma_t^2 = \sigma_{Jitter}^2 + \sigma_{TimeWalk}^2 + \sigma_{LandauNoise}^2 + \sigma_{Distortion}^2 + \sigma_{TDC}^2$$



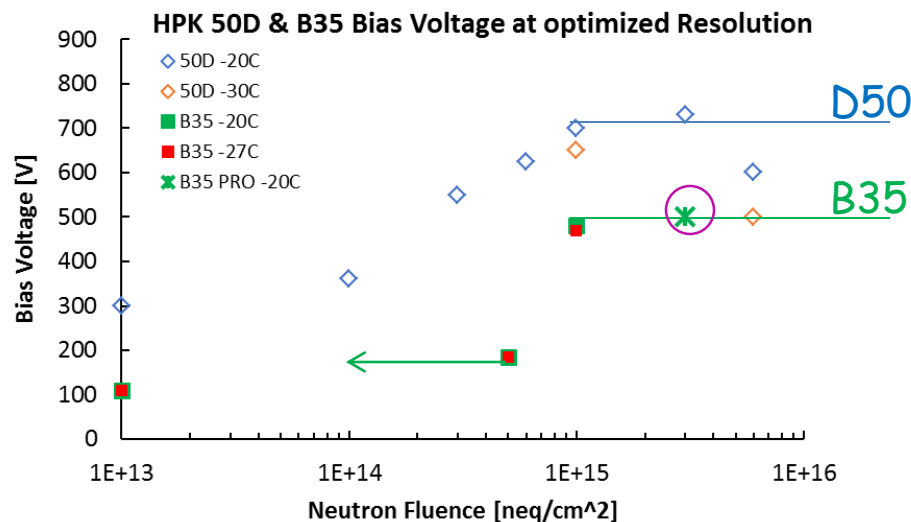
Resolution saturating in gain:

pre-rad: 50D and B35 same, indicates saturation of B35

“5e14” and 1e15: B35 is lower than 50D as expected

-> Both Landau fluctuation & low drift can saturate the resolution!

Bias and Time Resolution during Operation

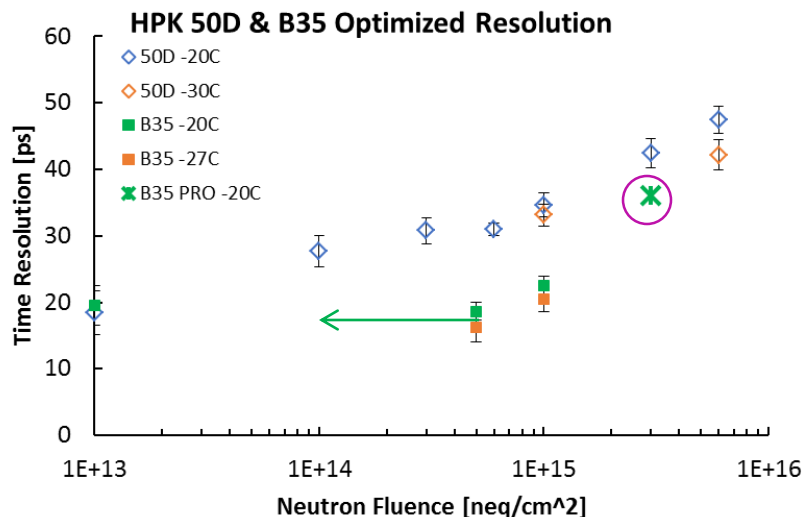


Bias Voltage to get optimum time resolution as a function of neutron fluence:

50D: Increases from 300 V pre-rad to 700 V beyond $1\text{e}15 \text{ n}/\text{cm}^2$

B35: Increases from 100 V to 500 V beyond $1\text{e}15 \text{ n}/\text{cm}^2$

Constant difference of 200 V



Optimized time resolution as a function of fluence:

B35 lower by $\sim 10 \text{ ps}$ wrt 50D.

Advantage of 35μm HPK LGAD

Biasing & Power

The bias voltage of B35 is 200 V lower than that of 50D.

Power of B35 can be 10x lower than that of 50D after irradiation

Time resolution:

$$\sigma_t = 27 \text{ ps up to } 1e15 \text{ n/cm}^2$$

$$\sigma_t = 36 \text{ ps for protons at } 3e15 \text{ n/cm}$$

$$\sigma_t \sim 10 \text{ ps better than 50D}$$

$$\sigma_t \sim 5 \text{ ps better at } -20 \text{ C} \rightarrow -27 \text{ C}$$

To be solved for 35 μm LGAD: (with WF2?)

Steep bias dependence of time resolution

-> (lower the doping concentration of the p-multiplication layer?)

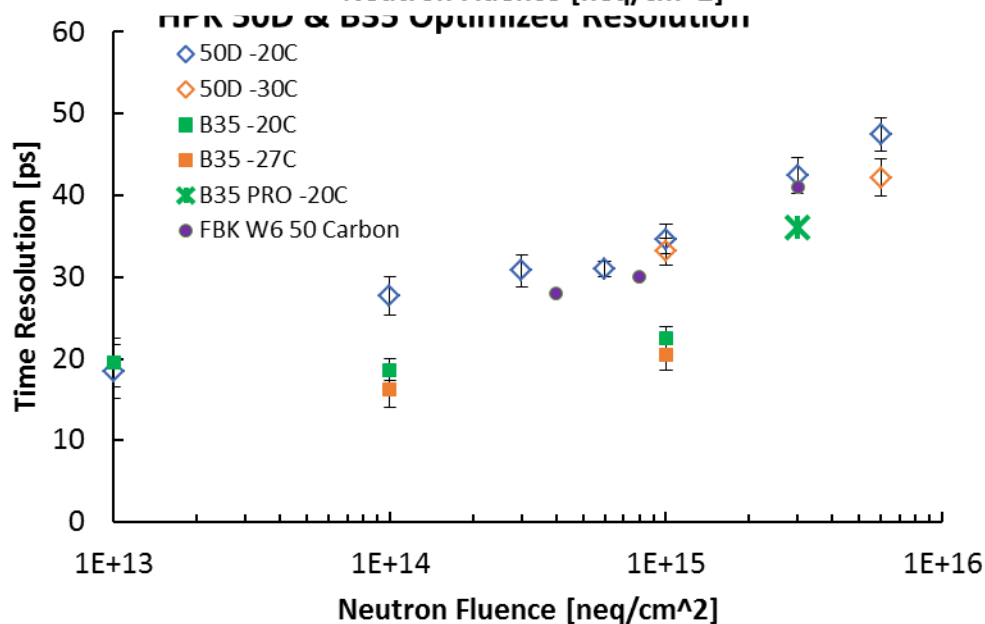
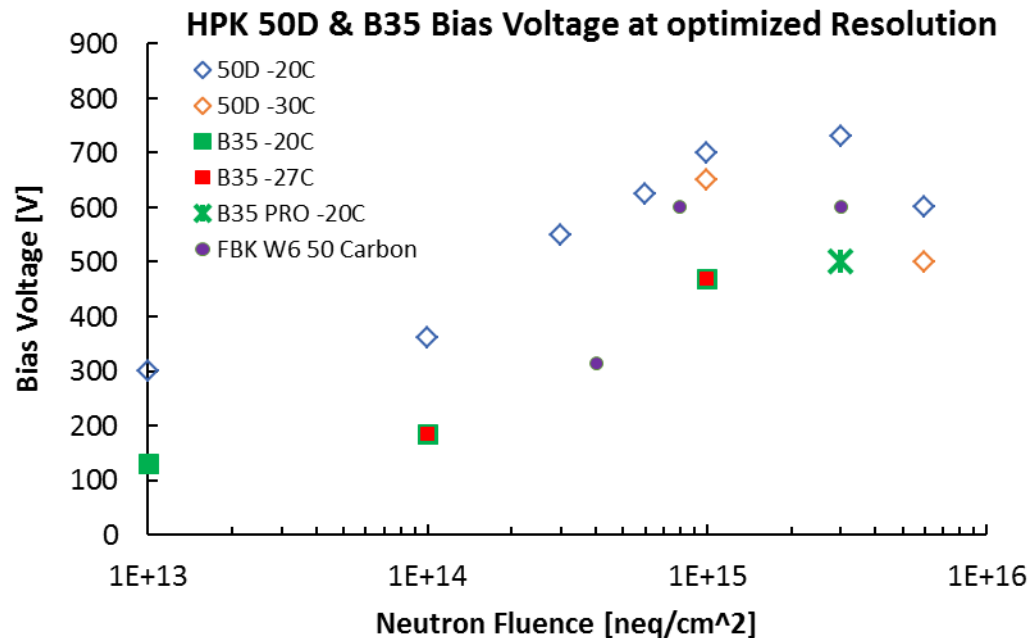
Pre-rad bias voltage too close to depletion voltage:

-> lower the bulk doping concentration to $\sim 1e12$

-> Lessons learned from proton data:

At very high fluences: bulk does not care if protons or neutrons had removed the acceptors in the multiplication layer

Where are we?





Contributors

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This work was partially performed within the CERN RD50 collaboration.



Back-up

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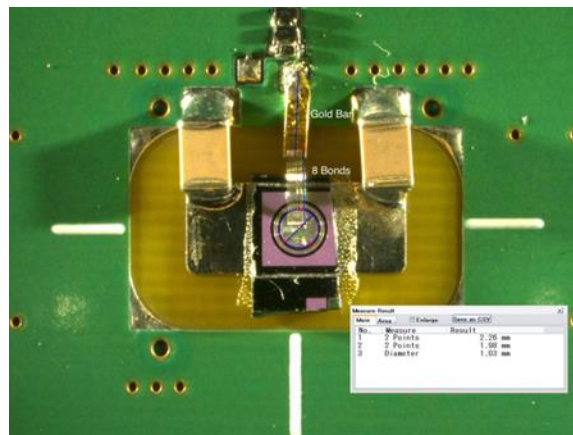
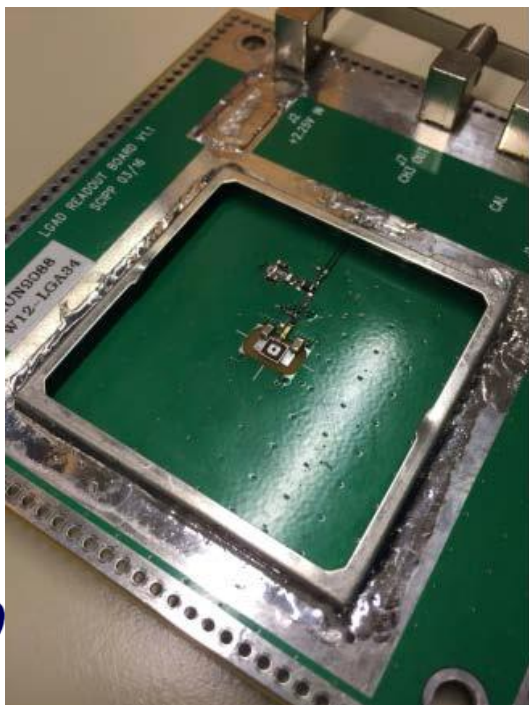
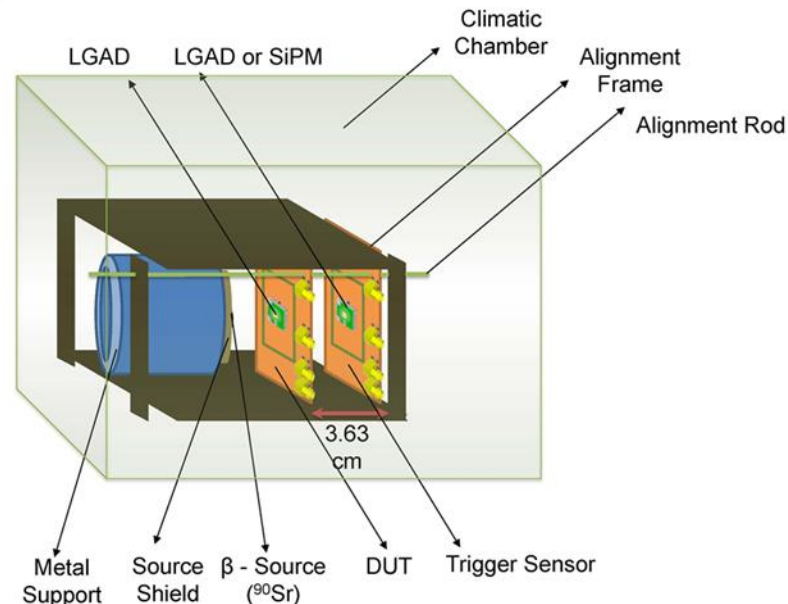
UCSC ^{90}Sr β -Source

^{90}Sr β -source Set-up:

DUT LGAD between source and trigger plane

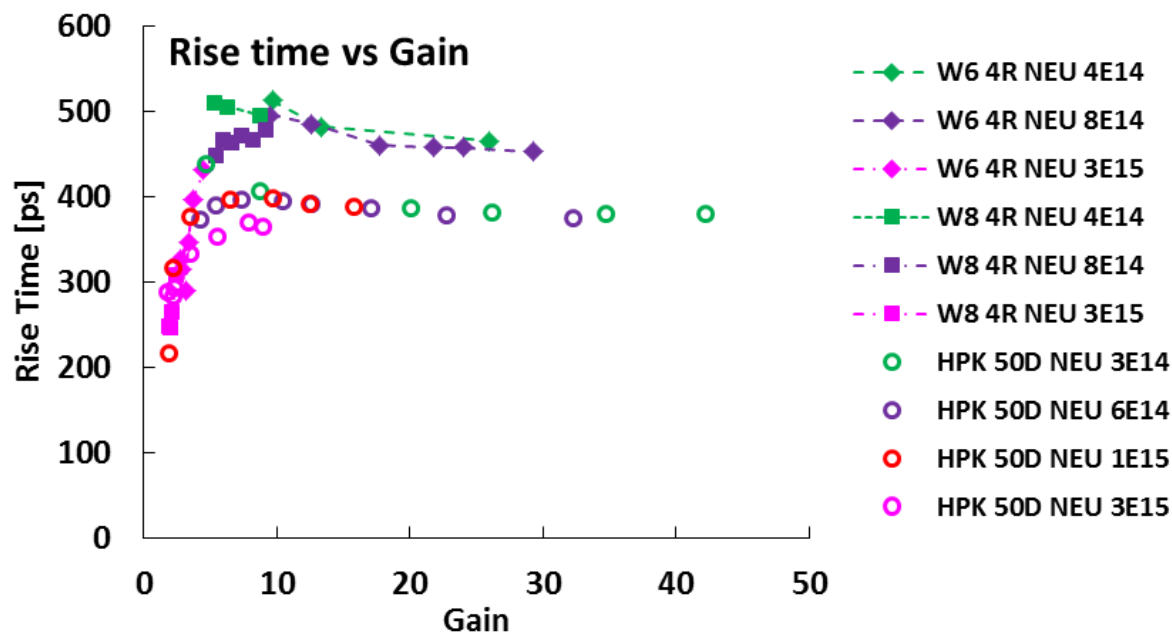
Trigger and time reference: known LGAD with known time resolution.

Climate chamber allows operation between -30°C and $+20^\circ\text{C}$.



Measurement of pulse shapes with amplifier board (Low-noise, fast $\sim 3\text{GHz}$) developed at UCSC, now available from CERN) and digital scope (2.2 GHz, 25 ps time digitization)

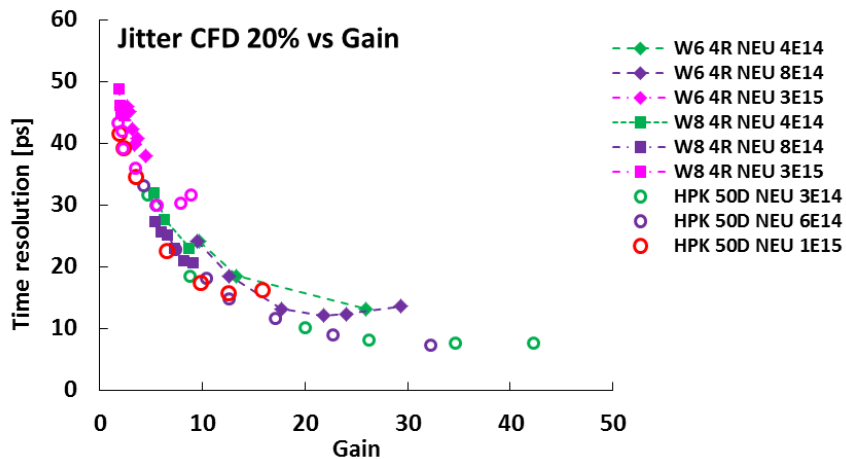
Gain Dependence of the Rise time (10-90%)



Same thickness for HPK W8 and W6

Different thickness FBK (60 μm) and HPK (50 μm) TBC

Jitter and Noise vs. Gain



$$\sigma_t^2 = \sigma_{Jitter}^2 + \sigma_{TimeWalk}^2 + \sigma_{LandauNoise}^2 + \sigma_{Distortion}^2 + \sigma_{TDC}^2$$

$$\sigma_{TimeWalk} = \left[\frac{V_{th}}{S/t_{rise}} \right]_{RMS} \propto \left[\frac{N}{dV} \right]_{RMS},$$

$$\sigma_{Jitter} = \frac{N}{dV/dt} \approx \frac{t_{rise}}{S/N}$$

noise excursions flatten the 1/gain dependence of the jitter

